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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Betuils	
Product Status	Active
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	40MHz
Connectivity	I ² C, IrDA, LINbus, PMP, SPI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, I ² S, POR, PWM, WDT
Number of I/O	19
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	·
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 3.6V
Data Converters	A/D 9x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	28-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mx210f016bt-v-ss

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

44

1

TABLE 14: PIN NAMES FOR 44-PIN USB DEVICES

44-PIN VTLA (TOP VIEW)^(1,2,3,5)

PIC32MX210F016D PIC32MX220F032D PIC32MX230F064D PIC32MX230F256D PIC32MX250F128D PIC32MX270F256D

Pin #	Full Pin Name	Pin #	Full Pin Name
1	RPB9/SDA1/CTED4/PMD3/RB9	23	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2
2	RPC6/PMA1/RC6	24	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3
3	RPC7/PMA0/RC7	25	AN6/RPC0/RC0
4	RPC8/PMA5/RC8	26	AN7/RPC1/RC1
5	RPC9/CTED7/PMA6/RC9	27	AN8/RPC2/PMA2/RC2
6	Vss	28	Vdd
7	VCAP	29	Vss
8	PGED2/RPB10/D+/CTED11/RB10	30	OSC1/CLKI/RPA2/RA2
9	PGEC2/RPB11/D-/RB11	31	OSC2/CLKO/RPA3/RA3
10	VUSB3V3	32	TDO/RPA8/PMA8/RA8
11	AN11/RPB13/CTPLS/PMRD/RB13	33	SOSCI/RPB4/RB4
12	PGED4 ⁽⁴⁾ /TMS/PMA10/RA10	34	SOSCO/RPA4/T1CK/CTED9/RA4
13	PGEC4 ⁽⁴⁾ /TCK/CTED8/PMA7/RA7	35	TDI/RPA9/PMA9/RA9
14	CVREFOUT/AN10/C3INB/RPB14/VBUSON/SCK1/CTED5/RB14	36	AN12/RPC3/RC3
15	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15	37	RPC4/PMA4/RC4
16	AVss	38	RPC5/PMA3/RC5
17	AVDD	39	Vss
18	MCLR	40	Vdd
19	PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0	41	RPB5/USBID/RB5
20	PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1	42	VBUS
21	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0	43	RPB7/CTED3/PMD5/INT0/RB7
22	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1	44	RPB8/SCL1/CTED10/PMD4/RB8

Note 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.

3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.

4: This pin function is not available on PIC32MX210F016D and PIC32MX220F032D devices.

5: Shaded pins are 5V tolerant.

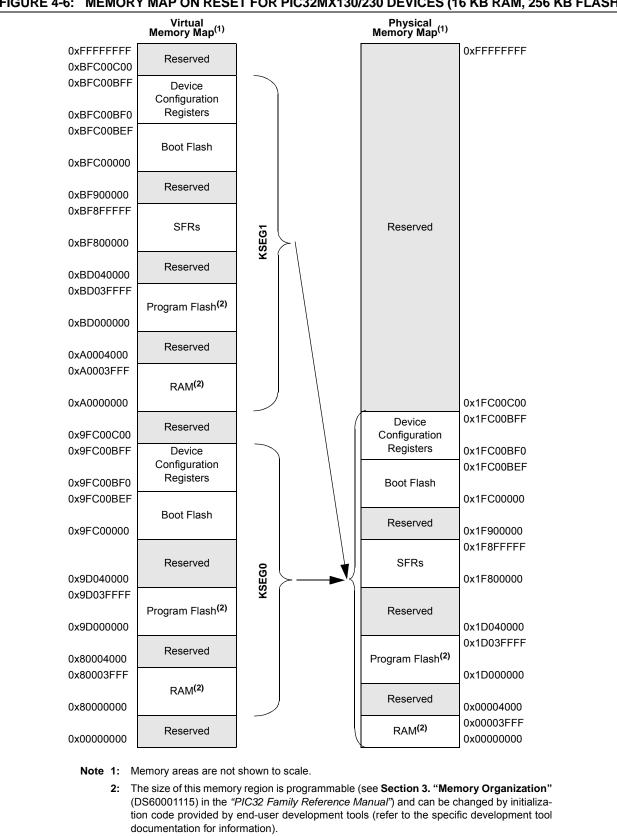


FIGURE 4-6: MEMORY MAP ON RESET FOR PIC32MX130/230 DEVICES (16 KB RAM, 256 KB FLASH)

4.2 Bus Matrix Control Registers

TABLE 4-2: BUS MATRIX REGISTER MAP

ess (a	Bits																
Virtual Address (BF88_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
2000	BMXCON ⁽¹⁾	31:16	—	_	_	_	-	_	_	_		—	_	BMXERRIXI	BMXERRICD	BMXERRDMA	BMXERRDS	BMXERRIS	001F
2000	BINIXCON	15:0			_	_		-		_		BMXWSDRM	_	_	-	В	MXARB<2:0>		0041
2010	BMXDKPBA ⁽¹⁾	31:16	—	_	_	_	-	_	_	_		—	_	—	_	_	_	—	0000
2010	DIVIAUNEDA	15:0									BN	IXDKPBA<15:0	>						0000
2020	BMXDUDBA ⁽¹⁾	31:16	_	_	_		_	—	_	_	_	—	_	_	_	_	_	_	0000
		15:0									BN	XDUDBA<15:0	>						0000
2030	BMXDUPBA ⁽¹⁾	31:16	—	—	—		—	—	—	—	—	—	—	—	—	—	—	—	0000
2000		15:0									BN	IXDUPBA<15:0	>						0000
2040	BMXDRMSZ	31:16									BM	XDRMSZ<31:0	>						xxxx
		15:0				1				1				1					xxxx
2050	BMXPUPBA ⁽¹⁾	31:16	—	—	—		—	-	—	_	_	_	—	—		BMXPUPBA	<19:16>		0000
		15:0									BN	IXPUPBA<15:0	>						0000
2060	BMXPFMSZ	31:16									BM	IXPFMSZ<31:0	>						xxxx
2000	2	15:0									5.								xxxx
2070	BMXBOOTSZ	31:16									BM	XBOOTSZ<31:0)>						0000
	# (20010E	15:0		DIVIADUUT 5Z<31:0>								0C00							

Legend: x = unknown value on Reset; - = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: This register has corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

PIC32MX1XX/2XX 28/36/44-PIN FAMILY

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24		—	_	_	_	_	_	—
00.40	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
23:16	CHSDIE	CHSHIE	CHDDIE	CHDHIE	CHBCIE	CHCCIE	CHTAIE	CHERIE
45.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15:8	—	—	_	_	—	—	_	—
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	CHSDIF	CHSHIF	CHDDIF	CHDHIF	CHBCIF	CHCCIF	CHTAIF	CHERIF

REGISTER 9-9: DCHxINT: DMA CHANNEL 'x' INTERRUPT CONTROL REGISTER

Legend:

•					
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 31-24	Unimplemented: Read as '0'	
bit 23	CHSDIE: Channel Source Done Interrupt Enable bit 1 = Interrupt is enabled	
bit 22	0 = Interrupt is disabled	
DIL 22	CHSHIE: Channel Source Half Empty Interrupt Enable bit 1 = Interrupt is enabled 0 = Interrupt is disabled	
bit 21	CHDDIE: Channel Destination Done Interrupt Enable bit 1 = Interrupt is enabled	
	0 = Interrupt is disabled	
bit 20	CHDHIE: Channel Destination Half Full Interrupt Enable bit 1 = Interrupt is enabled 0 = Interrupt is disabled	
bit 19	CHBCIE: Channel Block Transfer Complete Interrupt Enable bit 1 = Interrupt is enabled 0 = Interrupt is disabled	
bit 18	CHCCIE: Channel Cell Transfer Complete Interrupt Enable bit	
	 1 = Interrupt is enabled 0 = Interrupt is disabled 	
bit 17	CHTAIE: Channel Transfer Abort Interrupt Enable bit	
	1 = Interrupt is enabled0 = Interrupt is disabled	
bit 16	CHERIE: Channel Address Error Interrupt Enable bit 1 = Interrupt is enabled	
bit 15-8	0 = Interrupt is disabled Unimplemented: Read as '0'	
bit 7	CHSDIF: Channel Source Done Interrupt Flag bit	
	 1 = Channel Source Pointer has reached end of source (CHSPTR = CHSSIZ) 0 = No interrupt is pending 	
bit 6	CHSHIF: Channel Source Half Empty Interrupt Flag bit 1 = Channel Source Pointer has reached midpoint of source (CHSPTR = CHSSIZ/2) 0 = No interrupt is pending)
bit 5	CHDDIF: Channel Destination Done Interrupt Flag bit	
	 1 = Channel Destination Pointer has reached end of destination (CHDPTR = CHDSI 0 = No interrupt is pending 	IZ)
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DS60001168J-page 95

REGISTE	R 9-9: DCHxINT: DMA CHANNEL 'x' INTERRUPT CONTROL REGISTER (CONTINUED)
bit 4	CHDHIF: Channel Destination Half Full Interrupt Flag bit
	 1 = Channel Destination Pointer has reached midpoint of destination (CHDPTR = CHDSIZ/2) 0 = No interrupt is pending
bit 3	CHBCIF: Channel Block Transfer Complete Interrupt Flag bit
	 1 = A block transfer has been completed (the larger of CHSSIZ/CHDSIZ bytes has been transferred), or a pattern match event occurs 0 = No interrupt is pending
bit 2	CHCCIF: Channel Cell Transfer Complete Interrupt Flag bit
	1 = A cell transfer has been completed (CHCSIZ bytes have been transferred)0 = No interrupt is pending
bit 1	CHTAIF: Channel Transfer Abort Interrupt Flag bit
	 1 = An interrupt matching CHAIRQ has been detected and the DMA transfer has been aborted 0 = No interrupt is pending
bit 0	CHERIF: Channel Address Error Interrupt Flag bit
	 1 = A channel address error has been detected (either the source or the destination address is invalid) 0 = No interrupt is pending

DS60001168J-page 96

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0			
21.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0			
31:24	—	—	_	—	_	—	_	_			
22:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0			
23:16		_		_	_		_				
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
15:8	CHCSIZ<15:8>										
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
7:0		CHCSIZ<7:0>									

REGISTER 9-16: DCHxCSIZ: DMA CHANNEL 'x' CELL-SIZE REGISTER

Legend:R = Readable bitW = Writable bitU = Unimplemented bit, read as '0'-n = Value at POR'1' = Bit is set'0' = Bit is clearedx = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15-0 CHCSIZ<15:0>: Channel Cell Size bits

1111111111111111 = 65,535 bytes transferred on an event

REGISTER 9-17: DCHxCPTR: DMA CHANNEL 'x' CELL POINTER REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
04.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
31:24	_	—	—	—	_	—	—	—		
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
23:16	—	—	—	—	—	—	—	—		
45.0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0		
15:8	CHCPTR<15:8>									
7.0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0		
7:0				CHCPTF	R<7:0>					

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, r	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

Note: When in Pattern Detect mode, this register is reset on a pattern detect.

INE OIOT									
Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
31.24	—	—	-	—	_	_	—	_	
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
23.10	—	—	-	—	_	_	—	_	
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
15.0	—	—		—	_	_	—	_	
7:0	R-0	U-0	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	
7:0	UACTPND			USLPGRD	USBBUSY ⁽¹⁾	_	USUSPEND	USBPWR	

REGISTER 10-5: U1PWRC: USB POWER CONTROL REGISTER

Legend:

zogonai					
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 31-8 Unimplemented: Read as '0'

- bit 7 UACTPND: USB Activity Pending bit
 - 1 = USB bus activity has been detected; however, an interrupt is pending, which has yet to be generated
 0 = An interrupt is not pending
- bit 6-5 Unimplemented: Read as '0'
- bit 4 USLPGRD: USB Sleep Entry Guard bit
 - 1 = Sleep entry is blocked if USB bus activity is detected or if a notification is pending
 - 0 = USB module does not block Sleep entry
- bit 3 USBBUSY: USB Module Busy bit⁽¹⁾
 - 1 = USB module is active or disabled, but not ready to be enabled
 - 0 = USB module is not active and is ready to be enabled
- bit 2 Unimplemented: Read as '0'
- bit 1 USUSPEND: USB Suspend Mode bit
 - 1 = USB module is placed in Suspend mode
 - (The 48 MHz USB clock will be gated off. The transceiver is placed in a low-power state.)
 - 0 = USB module operates normally
- bit 0 USBPWR: USB Operation Enable bit
 - 1 = USB module is turned on
 - 0 = USB module is disabled

(Outputs held inactive, device pins not used by USB, analog features are shut down to reduce power consumption.)

Note 1: When USBPWR = 0 and USBBUSY = 1, status from all other registers is invalid and writes to all USB module registers produce undefined results.

REGISTER 17-1: SPIxCON: SPI CONTROL REGISTER (CONTINUED)

- bit 5 **MSTEN:** Master Mode Enable bit
 - 1 = Master mode
 - 0 = Slave mode
- bit 4 DISSDI: Disable SDI bit
 - 1 = SDI pin is not used by the SPI module (pin is controlled by PORT function)
 - 0 = SDI pin is controlled by the SPI module
- bit 3-2 STXISEL<1:0>: SPI Transmit Buffer Empty Interrupt Mode bits
 - 11 = Interrupt is generated when the buffer is not full (has one or more empty elements)
 - 10 = Interrupt is generated when the buffer is empty by one-half or more
 - 01 = Interrupt is generated when the buffer is completely empty
 - 00 = Interrupt is generated when the last transfer is shifted out of SPISR and transmit operations are complete
- bit 1-0 SRXISEL<1:0>: SPI Receive Buffer Full Interrupt Mode bits
 - 11 = Interrupt is generated when the buffer is full
 - 10 = Interrupt is generated when the buffer is full by one-half or more
 - 01 = Interrupt is generated when the buffer is not empty
 - 00 = Interrupt is generated when the last word in the receive buffer is read (i.e., buffer is empty)
- **Note 1:** When using the 1:1 PBCLK divisor, the user's software should not read or write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.
 - 2: This bit can only be written when the ON bit = 0.
 - 3: This bit is not used in the Framed SPI mode. The user should program this bit to '0' for the Framed SPI mode (FRMEN = 1).
 - 4: When AUDEN = 1, the SPI module functions as if the CKP bit is equal to '1', regardless of the actual value of CKP.

20.0 PARALLEL MASTER PORT (PMP)

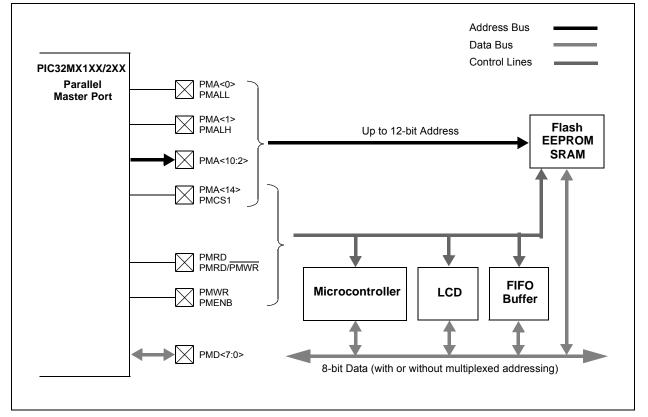
Note:	This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 13. "Parallel Master Port (PMP)" (DS60001128),
	which is available from the <i>Documentation</i> > <i>Reference Manual</i> section of the Microchip PIC32 web site (www.microchip.com/pic32).

The PMP is a parallel 8-bit input/output module specifically designed to communicate with a wide variety of parallel devices, such as communications peripherals, LCDs, external memory devices and microcontrollers. Because the interface to parallel peripherals varies significantly, the PMP module is highly configurable. Key features of the PMP module include:

- Fully multiplexed address/data mode
- Demultiplexed or partially multiplexed address/ data mode
 - up to 11 address lines with single Chip Select
 - up to 12 address lines without Chip Select
- One Chip Select line
- Programmable strobe options
 - Individual read and write strobes or;
 - Read/write strobe with enable strobe
- · Address auto-increment/auto-decrement
- Programmable address/data multiplexing
- Programmable polarity on control signals
- · Legacy parallel slave port support
- · Enhanced parallel slave support
- Address support
- 4-byte deep auto-incrementing buffer
- · Programmable Wait states
- · Selectable input voltage levels

Figure 20-1 illustrates the PMP module block diagram.

FIGURE 20-1: PMP MODULE PINOUT AND CONNECTIONS TO EXTERNAL DEVICES



NOTES:

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
04.04	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x		
31:24	—	_	HR10	<1:0>		HR01	<3:0>			
00.40	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x		
23:16			MIN10<2:0>		MIN01<3:0>					
45.0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x		
15:8	_		SEC10<2:0>		SEC01<3:0>					
7.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
7:0	—	_	_	_	_	_	_	_		
							•			
Legend:										

REGISTER 21-3: RTCTIME: RTC TIME VALUE REGISTER

R = Readable bitW = Writable bitU = Unimplemented bit, read as '0'-n = Value at POR'1' = Bit is set'0' = Bit is clearedx = Bit is

bit 31-30 Unimplemented: Read as '0'

bit 29-28 HR10<1:0>: Binary-Coded Decimal Value of Hours bits, 10s place digit; contains a value from 0 to 2

bit 27-24 **HR01<3:0>:** Binary-Coded Decimal Value of Hours bits, 1s place digit; contains a value from 0 to 9 bit 23 **Unimplemented:** Read as '0'

bit 22-20 MIN10<2:0>: Binary-Coded Decimal Value of Minutes bits, 10s place digit; contains a value from 0 to 5

bit 19-16 **MIN01<3:0>:** Binary-Coded Decimal Value of Minutes bits, 1s place digit; contains a value from 0 to 9 bit 15 **Unimplemented:** Read as '0'

bit 14-12 SEC10<2:0>: Binary-Coded Decimal Value of Seconds bits, 10s place digit; contains a value from 0 to 5

bit 11-8 **SEC01<3:0>:** Binary-Coded Decimal Value of Seconds bits, 1s place digit; contains a value from 0 to 9

bit 7-0 Unimplemented: Read as '0'

Note: This register is only writable when RTCWREN = 1 (RTCCON<3>).

x = Bit is unknown

24.1 Comparator Voltage Reference Control Register

TABLE 24-1 :	COMPARATOR VOLTAGE REFERENCE REGISTER MAP
---------------------	---

ress t)		0		Bits									ŝ						
Virtual Addr (BF80_#)	80_#	Rang	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
0000	CVRCON	31:16	_	_	—	—	_	—	_	_	—	—	—	_	—	_	_	—	0000
9800	CVRCON	15:0	ON	_	_	_	_	_	_	_	_	CVROE	CVRR	CVRSS		CVR<	3:0>		0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

PIC32MX1XX/2XX 28/36/44-PIN FAMILY

NOTES:

DC CHARACTERISTICS			$\begin{array}{llllllllllllllllllllllllllllllllllll$					
Param.	Symbol	Characteristic	Min.	Тур.	Max.	Units	Conditions	
DO10	Vol	Output Low Voltage	_	_	0.4	V	$\text{IOL} \leq 10 \text{ mA, VDD} = 3.3 \text{V}$	
		Output High Voltage	1.5 (1)	_	_		IOH \ge -14 mA, VDD = 3.3V	
0000	Vон	I/O Pins	2.0 ⁽¹⁾	_	_	v	IOH \geq -12 mA, VDD = 3.3V	
DO20	VOH		2.4	_	_	v	IOH \geq -10 mA, VDD = 3.3V	
			3.0(1)	—	—		$IOH \ge -7 \text{ mA}, \text{ VDD} = 3.3 \text{V}$	

TABLE 30-10: DC CHARACTERISTICS: I/O PIN OUTPUT SPECIFICATIONS

Note 1: Parameters are characterized, but not tested.

TABLE 30-11: ELECTRICAL CHARACTERISTICS: BOR

DC CHARACTERISTICS			$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$							
Param. No.	Symbol	Characteristics	Min. ⁽¹⁾	Typical	Max.	Units	Conditions			
BO10	VBOR	BOR Event on VDD transition high-to-low ⁽²⁾	2.0		2.3	V	_			

Note 1: Parameters are for design guidance only and are not tested in manufacturing.

2: Overall functional device operation at VBORMIN < VDD < VDDMIN is tested, but not characterized. All device Analog modules, such as ADC, etc., will function, but with degraded performance below VDDMIN.

DC CHARACTERISTICS				$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$						
Param. No.	Symbol	Characteristics	Min.	Typical ⁽¹⁾	Typical ⁽¹⁾ Max. Units Conditions					
		Program Flash Memory ⁽³⁾								
D130	Eр	Cell Endurance	20,000	—	_	E/W	—			
D131	Vpr	VDD for Read	2.3	—	3.6	V	—			
D132	VPEW	VDD for Erase or Write	2.3	—	3.6	V	—			
D134	Tretd	Characteristic Retention	20	—	_	Year	Provided no other specifications are violated			
D135	IDDP	Supply Current during Programming	_	10	_	mA	—			
	Tww	Word Write Cycle Time	—	411	_	es	See Note 4			
D136	Trw	Row Write Cycle Time	—	6675	_	Cycles	See Note 2,4			
D137	TPE	Page Erase Cycle Time	—	20011	_		See Note 4			
	TCE	Chip Erase Cycle Time	—	80180	_	FRC	See Note 4			

TABLE 30-12: DC CHARACTERISTICS: PROGRAM MEMORY

Note 1: Data in "Typical" column is at 3.3V, 25°C unless otherwise stated.

2: The minimum SYSCLK for row programming is 4 MHz. Care should be taken to minimize bus activities during row programming, such as suspending any memory-to-memory DMA operations. If heavy bus loads are expected, selecting Bus Matrix Arbitration mode 2 (rotating priority) may be necessary. The default Arbitration mode is mode 1 (CPU has lowest priority).

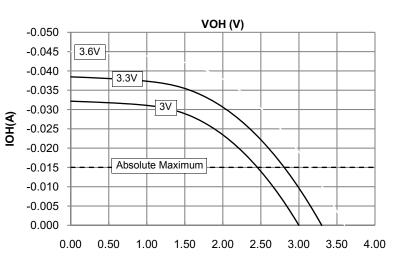
3: Refer to the *"PIC32 Flash Programming Specification"* (DS60001145) for operating conditions during programming and erase cycles.

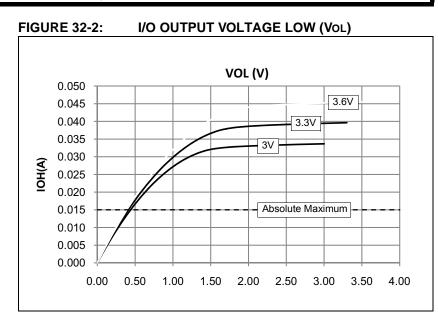
4: This parameter depends on FRC accuracy (See Table 30-19) and FRC tuning values (See Register 8-2).

32.0 DC AND AC DEVICE CHARACTERISTICS GRAPHS

Note: The graphs provided following this note are a statistical summary based on a limited number of samples and are provided for design guidance purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore, outside the warranted range.

FIGURE 32-1: I/O OUTPUT VOLTAGE HIGH (VOH)

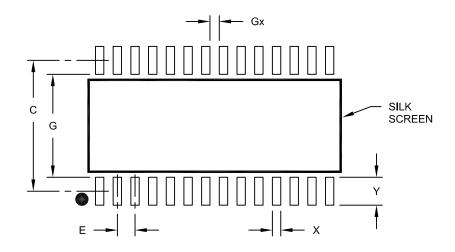




NOTES:

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	MILLIMETERS				
Dimensio	n Limits	MIN	NOM	MAX	
Contact Pitch	E		1.27 BSC		
Contact Pad Spacing	С		9.40		
Contact Pad Width (X28)	X			0.60	
Contact Pad Length (X28)	Y			2.00	
Distance Between Pads	Gx	0.67			
Distance Between Pads	G	7.40			

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2052A

U1OTGSTAT (USB OTG Status)	110
U1PWRC (USB Power Control)	112
U1SOF (USB SOF Threshold)	123
U1STAT (USB Status)	118
U1TOK (USB Token)	122
UxMODE (UARTx Mode)	
UxSTA (UARTx Status and Control)	185
WDTCON (Watchdog Timer Control)	155
Resets	
Revision History	
RTCALRM (RTC ALARM Control)	

S

Serial Peripheral Interface (SPI)	165
Software Simulator (MPLAB SIM)	
Special Features	239

Т

Timer1 Module Timer2/3, Timer4/5 Modules Timing Diagrams	
10-Bit Analog-to-Digital Conversion	
(ASAM = 0, SSRC<2:0> = 000)	293
10-Bit Analog-to-Digital Conversion (ASAM = 1,	
SSRC<2:0> = 111, SAMC<4:0> = 00001)	294
EJTAG	300
External Clock	269
I/O Characteristics	272
I2Cx Bus Data (Master Mode)	283
I2Cx Bus Data (Slave Mode)	286
I2Cx Bus Start/Stop Bits (Master Mode)	283
I2Cx Bus Start/Stop Bits (Slave Mode)	286
Input Capture (CAPx)	276
OCx/PWM	
Output Compare (OCx)	277
Parallel Master Port Read	296
Parallel Master Port Write	297

Parallel Slave Port	. 295
SPIx Master Mode (CKE = 0)	. 278
SPIx Master Mode (CKE = 1)	. 279
SPIx Slave Mode (CKE = 0)	. 280
SPIx Slave Mode (CKE = 1)	. 281
Timer1, 2, 3, 4, 5 External Clock	. 275
UART Reception	. 187
UART Transmission (8-bit or 9-bit Data)	. 187
Timing Requirements	
CLKO and I/O	. 272
Timing Specifications	
I2Cx Bus Data Requirements (Master Mode)	
I2Cx Bus Data Requirements (Slave Mode)	
Input Capture Requirements	
Output Compare Requirements	
Simple OCx/PWM Mode Requirements	
SPIx Master Mode (CKE = 0) Requirements	
SPIx Master Mode (CKE = 1) Requirements	
SPIx Slave Mode (CKE = 1) Requirements	
SPIx Slave Mode Requirements (CKE = 0)	. 280
Timing Specifications (50 MHz)	
SPIx Master Mode (CKE = 0) Requirements	
SPIx Master Mode (CKE = 1) Requirements	
SPIx Slave Mode (CKE = 1) Requirements	
SPIx Slave Mode Requirements (CKE = 0)	. 305
U	
LIADT	101

UART	
USB On-The-Go (OTG)	103
V	
VCAP nin	250

VCAP pin	
Voltage Regulator (On-Chip)	250
W	
M/M/M/ Addross	3/1

WWW Address	. 341
WWW, On-Line Support	16

NOTES: